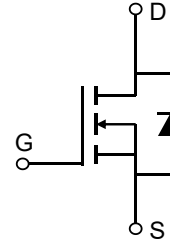


Description

Features

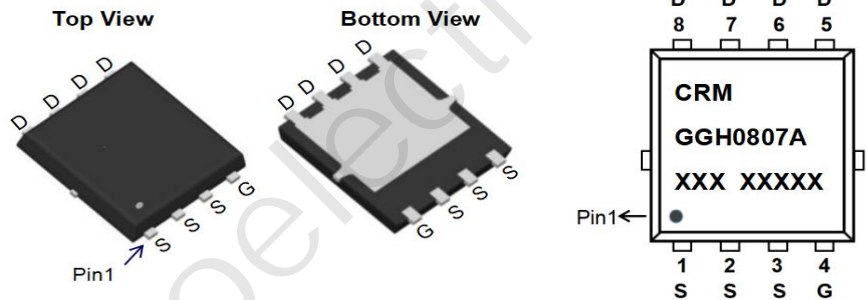
- 85V, 63A
- $R_{DS(ON)}$ Typ = 7.7mΩ @ $V_{GS} = 10V$
- Advanced Split Gate Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔV_{ds} TESTED!



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGH0807A	CRMGGH0807A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Units	
V _{DS}	Drain-to-Source Voltage	85	V	
V _{GS}	Gate-to-Source Voltage	±20	V	
I _D	Continuous Drain Current	T _C = 25°C	63	A
		T _C = 100°C	37.8	A
I _{DM}	Pulsed Drain Current ⁽¹⁾	252	A	
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾	81	mJ	
P _D	Power Dissipation	T _C = 25°C	68	W
R _{θJC}	Thermal Resistance, Junction to Case	1.83	°C/W	
T _J , T _{STG}	Junction & Storage Temperature Range	-55 to 150	°C	

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	85	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 85V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 20A	-	7.7	10	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 40V, f = 1MHz	-	1136	-	pF
C _{oss}	Output Capacitance		-	391	-	pF
C _{rss}	Reverse Transfer Capacitance		-	15	-	pF
Q _g	Total Gate Charge	V _{GS} = 0 to 10V V _{DS} = 40V, I _D = 10A	-	26	-	nC
Q _{gs}	Gate Source Charge		-	9	-	nC
Q _{gd}	Gate Drain("Miller") Charge		-	8	-	nC
Switching Characteristics						
t _{d(on)}	Turn-On DelayTime	V _{GS} = 10V, V _{DD} = 40V I _D = 10A, R _{GEN} = 3Ω	-	15	-	ns
t _r	Turn-On Rise Time		-	10	-	ns
t _{d(off)}	Turn-Off DelayTime		-	30	-	ns
t _f	Turn-Off Fall Time		-	15	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	63	A
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	252	A
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
t _{rr}	Body Diode Reverse Recovery Time	I _F = 10A, di/dt = 100A/us	-	50	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge		-	60	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. E_{AS} condition: Starting T_J=25°C, V_{DD}=40V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=18A
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

Test Circuit

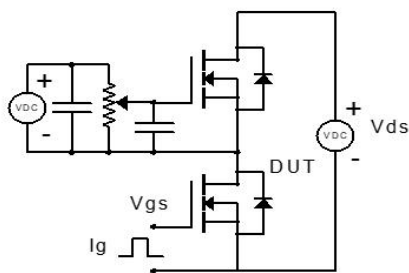


Figure 1: Gate Charge Test Circuit & Waveform

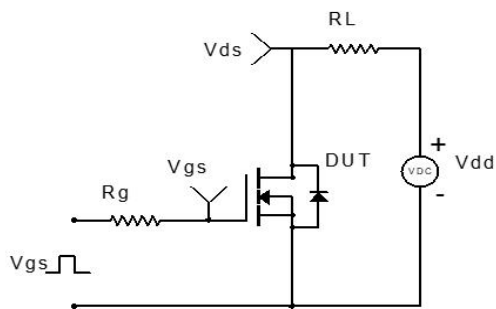


Figure 2: Resistive Switching Test Circuit & Waveform

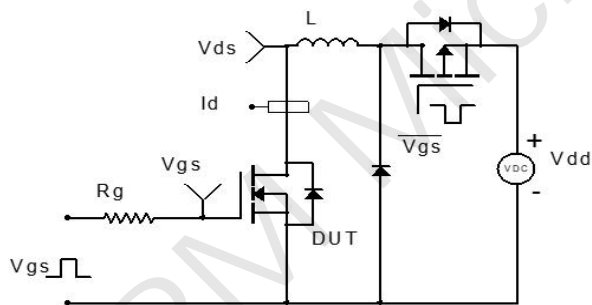


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

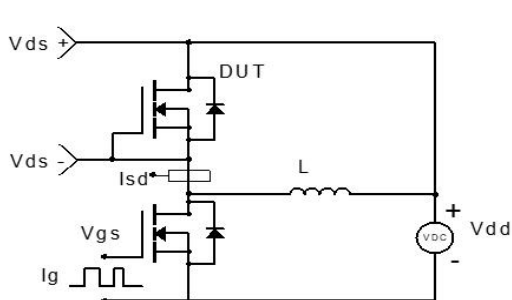
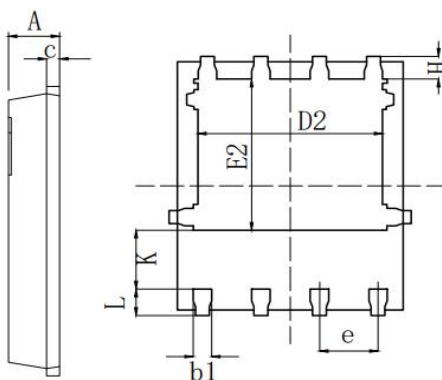
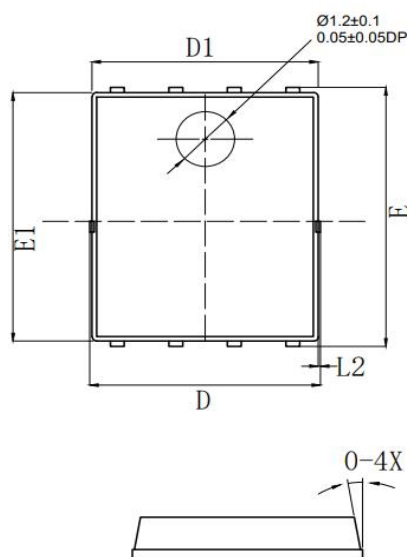


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(PDFN5x6-8L)




SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.90	1.00	1.10
b	0.25	0.30	0.35
b1	0.30	0.40	0.45
c	0.22	0.25	0.28
D	—	—	5.30
D1	4.90	5.05	5.20
D2	3.90REF		
E	6.00	6.15	6.30
E1	5.70	5.85	6.00
E2	3.50REF		
e	1.10	1.27	1.40
H	0.51	0.61	0.71
K	1.10	—	—
L	0.51	0.61	0.71
L2	—	—	0.10
Φ	8°	—	12°

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